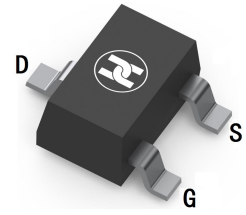
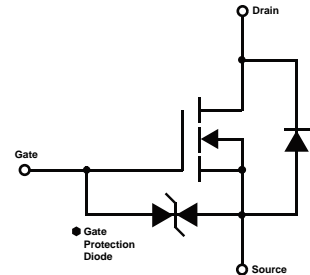


MOSFET (N-CHANNEL)
FEATURES

- Low On-Resistance: $R_{DS(ON)}$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage

MECHANICAL DATA

- Case: SOT-23
- Case Material: Molded Plastic. UL flammability
- Classification Rating: 94V-0
- Weight: 0.008 grams (approximate)
- Marking: 6C


SOT-23

Equivalent circuit
MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	60	V
Gate-source voltage	V_{GS}	$\pm 20\text{V}$	V
Continuous drain current	I_D	300	mA
Pulsed drain current (Note 1)	I_{DM}	800	mA
Power dissipation	P_D	0.35	W
Thermal resistance from Junction to ambient	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Junction And Storage temperature Range	T_J, T_{STG}	-65 ~ +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

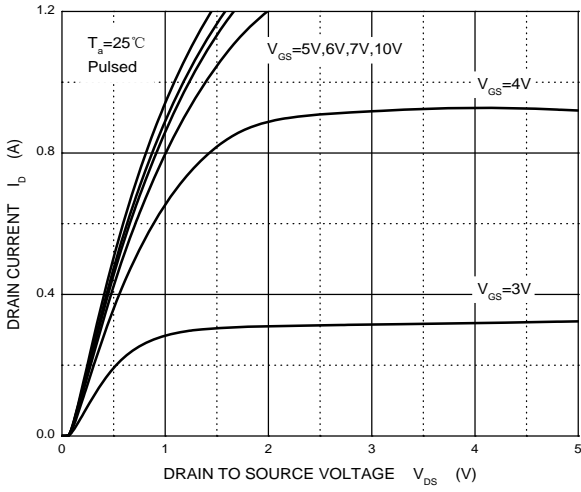
Parameter	Symb	Min	Typ	Max	Unit	Conditions
Static Characteristics						
Drain-Source breakdown voltage	$V_{(BR)DSS}$	60			V	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$
Gate-threshold voltage (note 1)	$V_{GS(\theta)}$	0.82		1.47	V	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$
Zero gate voltage drain current	I_{DSS}			400	μA	$V_{DS}=55\text{V}, V_{GS}=0\text{V}$
Gate-body leakage current	I_{GSS}			± 6	μA	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$
Drain-source on-resistance (note 1)	$R_{DS(ON)}$			2.25	Ω	$V_{GS}=4.5\text{V}, I_D=0.2\text{A}$
				1.44	Ω	$V_{GS}=10\text{V}, I_D=0.5\text{A}$
Diode forward voltage (note 1)	V_{SD}			1.35	V	$I_S=0.5\text{A}, V_{GS}=0\text{V}$
Gate-Source Breakdown Voltage	BV_{GSO}	± 20		± 30	V	$I_{GS}=\pm 1\text{mA}$ (Open Drain)
Recovered charge	Q_r		30		nC	$V_{GS}=0\text{V}, I_S=0.3\text{A}, V_R=25\text{V}, dI_S/dt=-100\text{A}/\mu\text{S}$
Dynamic Characteristics						
Input capacitance	C_{iss}			40	pF	$V_{DS}=10\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$
Output capacitance	C_{oss}			30	pF	
Reverse transfer capacitance	C_{rss}			10	pF	
Switching Characteristics						
Turn-on delay time	$t_{d(on)}$		3		nS	$V_{DD}=50\text{V}, V_{GS}=10\text{V}, R_G=50\Omega, R_{GS}=50\Omega, R_L=250\Omega$
Turn-off delay time	$t_{d(off)}$		15		nS	
Reverse recovery time	t_{rr}		26		nS	$V_{GS}=0\text{V}, I_S=0.3\text{A}, V_R=25\text{V}, dI_S/dt=-100\text{A}/\mu\text{S}$

Note:1. Pulse test ; Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

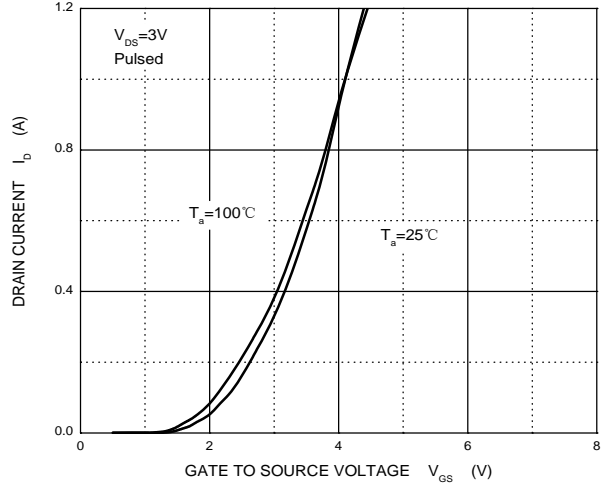
MOSFET (N-CHANNEL)

Typical Characteristics

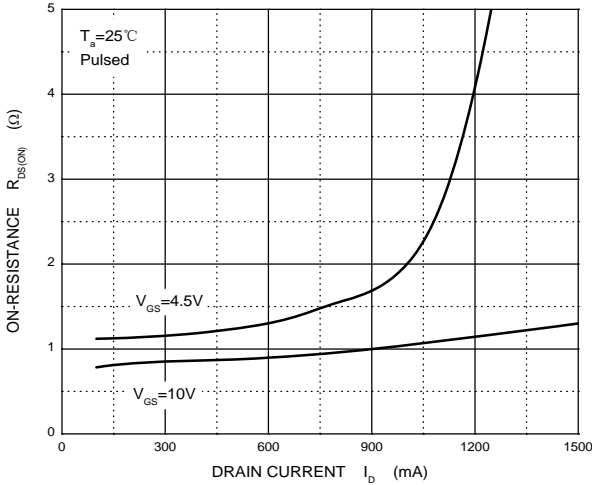
Output Characteristics



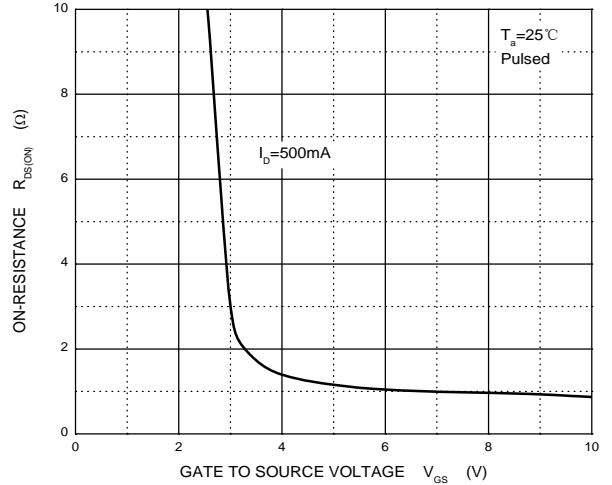
Transfer Characteristics



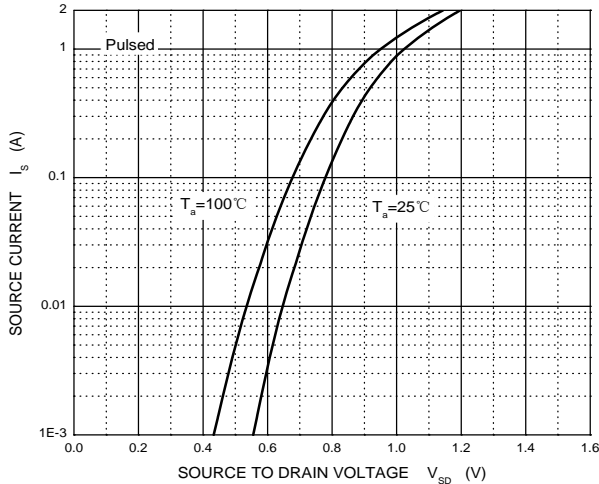
$R_{DS(ON)}$ — I_D



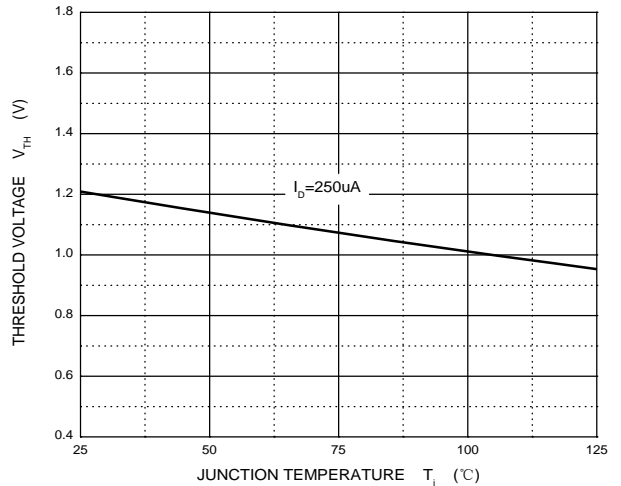
$R_{DS(ON)}$ — V_{GS}

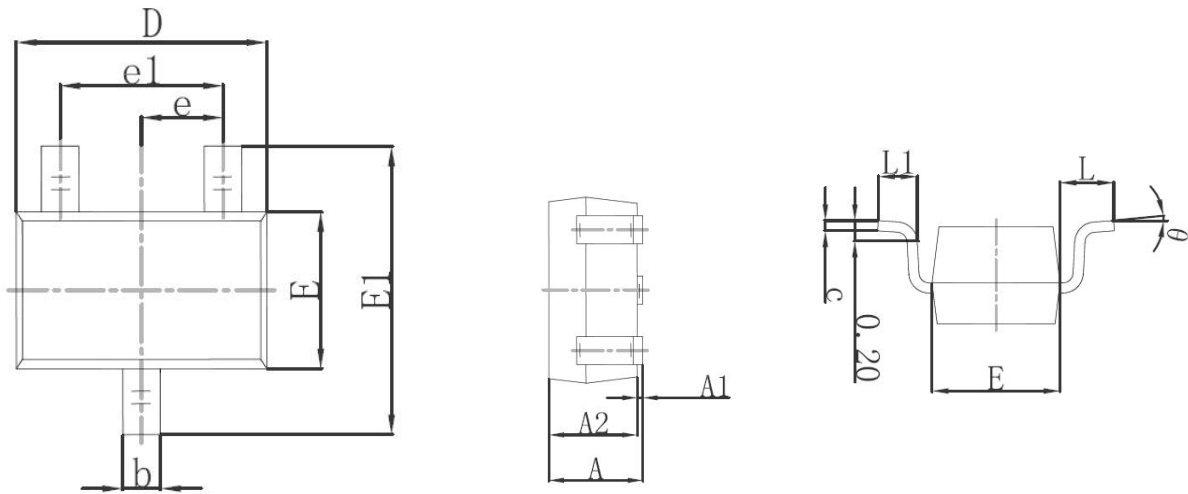


I_S — V_{SD}

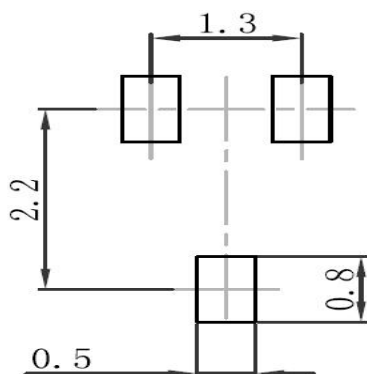


Threshold Voltage



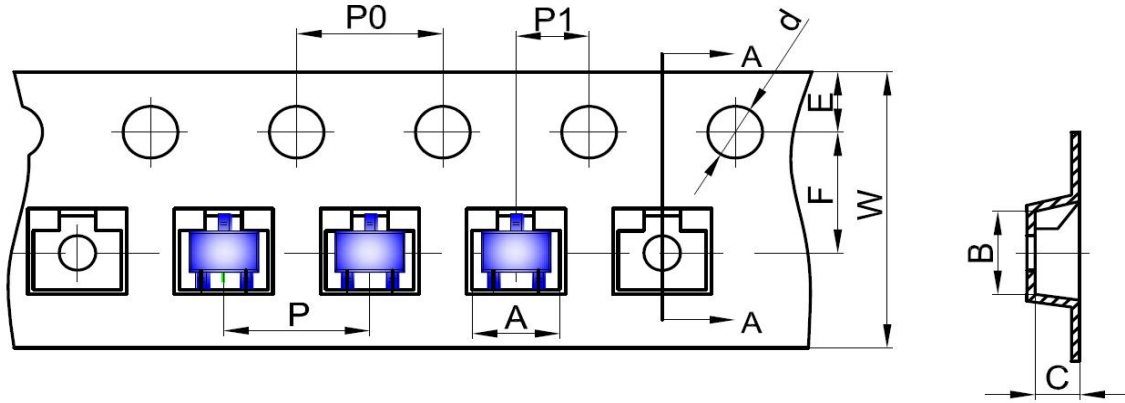
MOSFET (N-CHANNEL)
SOT-323 Package Outline Dimensions


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650TYP		0.026TYP	
e1	1.200	1.400	0.047	0.055
L	0.525REF		0.021REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

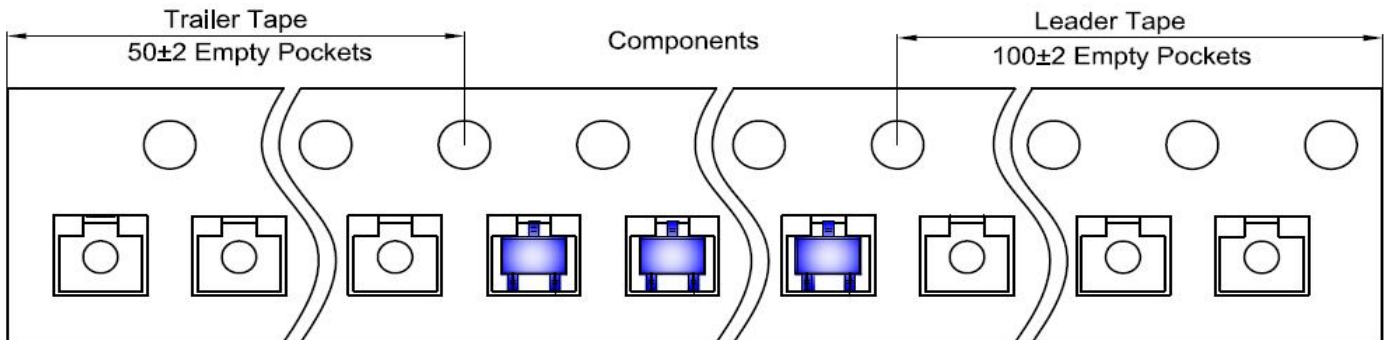
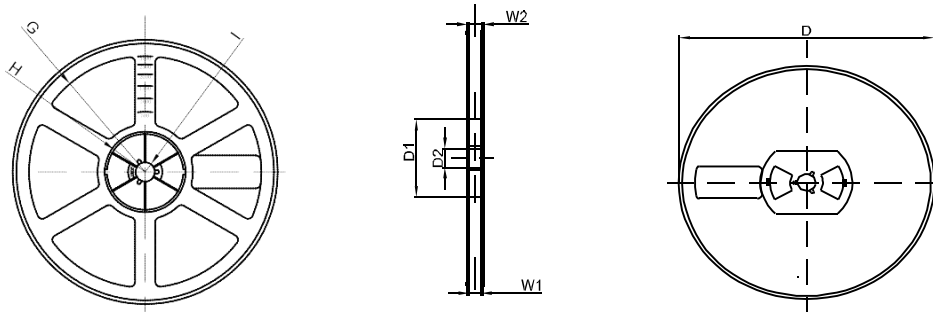
SOT-323 Suggested Pad Layout

Note:

1. Controlling dimension: in millimeters
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purposes only

MOSFET (N-CHANNEL)

SOT-323 Tape and Reel
SOT-323 Embossed Carrier Tape


DIMENSIONS ARE IN MILLIMETER										
TYPE	A	B	C	d	E	F	P0	P	P1	W
SOT-323	2.25	2.55	1.19	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00
TOLERANCE	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1

SOT-323 Tape Leader and Trailer

SOT-323 Reel


DIMENSIONS ARE IN MILLIMETER								
REEL OPTION	D	D1	D2	G	H	I	W1	W2
7" DIA	Ø178	54.40	13.00	R78	R25.60	R6.50	9.50	12.30
TOLERANCE	±2	±1	±1	±1	±1	±1	±1	±1